

APPLICATION DATA SHEET**Application Information**

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

Computer Readable Form (CRF)?:: No

Number of copies of CRF::

Title :: SEMICONDUCTOR DEVICE PACKAGE AND
METHOD OF MANUFACTURE

Attorney Docket Number:: 851663.458

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 9

Small Entity?:: No

Petition included?:: No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No::

Secrecy Order in Parent Appl.?:: No

First Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Singapore
Status::	Full Capacity
Given Name::	Kum-Weng
Middle Name::	
Family Name::	Loo
Name Suffix::	
City of Residence::	Singapore
State or Province of Residence::	
Country of Residence::	Singapore
Street of mailing address::	82 Pemimpin Place
City of mailing address::	Singapore
State or Province of mailing address::	
Country of mailing address::	Singapore
Postal or Zip Code of mailing address::	576079

Second Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Singapore
Status::	Full Capacity
Given Name::	Chek-Lim
Middle Name::	
Family Name::	Kho
Name Suffix::	
City of Residence::	Singapore
State or Province of Residence::	
Country of Residence::	Singapore
Street of mailing address::	Blk 142, #23-176, Toa Payoh Lorong 2

City of mailing address:: Singapore

State or Province of mailing address::

Country of mailing address:: Singapore

Postal or Zip Code of mailing address:: 310142

Correspondence Information

Correspondence Customer Number :: **38106**

Representative Information

Representative Customer Number::		38106
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Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Singapore	200206897-1	11/15/02	Yes

Assignee Information

Assignee name::	STMicroelectronics Asia Pacific Pte Ltd
Street of mailing address::	28 Ang Mo Kio Industrial Park 2
City of mailing address::	Singapore
State or Province of mailing address::	
Country of mailing address::	Singapore
Postal or Zip Code of mailing address::	569508

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